IPC ASSOCIATION COI	Material Composition © Copyright 2005. international and Page	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x Form Type Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					erials and N	Afg Informat	ion		
upplier In	nformation				·										
Company name*				Company unique ID			Unique ID Authority				Respon	Response Date*			
onsemi											2025-0	2025-06-03			
Contact Name	e	Title - Contact			I	Phone - Contact*				Email	Email - Contact*				
Product-Env	-Stewards		Product Enviro Compliance]	NA				Produ	Product-Env-Stewards@onsemi.com			
uthorized R	epresentative*	Title - Representative			I	Phone - Representative*				Email	Email - Representative*				
Product-Env-Stewards Pro				Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Re	equester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type	
		2SC6097-TL-E BIP NPN 3A		BIP NPN 3A 60V	3A 60V		2025-06-03 CNG		CNG	281.12		mg	Each		
	ring Proccess Informa		Cerminal Base	Alloy	-STD-020 MS	I Pating	Dank Proc	ass Rody 7	Camparatus	May Time at Da	ak Tampar	ntura Numb	per of Reflow Cyo	alac	
· · ·		CU Allov 1		-31D-020 Mis	or Kanng	260	k Process Body Temperat		ure Max Time at Peak Tempera 30 seco			bei of Kellow Cyt	nes		
omments	itanio Di		Alloy	1			200		10	30	Iseco	nus J			
	mum time at peak temperat	ure during so	ldering is 10.3	SO seconds											
	ormation regarding materia														

RoHS Material Composition Declaration			Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, itssuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required f Requester) and click on Submit Form to ha		Accepted" on the Supplier Acceptance drop-dow	n. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	astislav Drska	-En								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.44	mg	Supplier	Silicon (Si)	7440-21-3		0.44	mg
Die Attach Solder	0.22	mg	Supplier	Silver (Ag)	7440-22-4		0.0055	mg
			A	Lead (Pb)	7439-92-1	7a	0.2035	mg
			Supplier	Tin (Sn)	7440-31-5		0.011	mg
Lead Frame	146.44	mg	Supplier	Silver (Ag)	7440-22-4		0.3807	mg
			Supplier	Tin (Sn)	7440-31-5		0.205	mg
			Supplier	Copper (Cu)	7440-50-8		145.8542	mg
Mold Compound-Black	130.26	mg		Brominated epoxy resin	proprietary data		1.8236	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		5.8617	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		1.1723	mg
			Supplier	Carbon Black (C)	1333-86-4		1.3026	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		97.695	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		22.1442	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.2605	mg
Plating	3.34	mg	В	Bismuth (Bi)	7440-69-9		0.02	mg
-			Supplier	Tin (Sn)	7440-31-5		3.32	mg
Wire Bond - Au	0.42	mg	Supplier	Gold (Au)	7440-57-5		0.42	mg